CALL FOR PAPERS

22th IEEE/ACIS International Conference on Software Engineering, Artificial Intelligence, Networking and Parallel/Distributed Computing
(IEEE/ACIS SNPD 2021)
July 7-9, 2021
Taichung, Taiwan
http://www.acisinternational.org/snpd2021/
Sponsored by IEEE and ACIS, USA.
National Chin-Yi University of Technology, Taiwan

Important Dates

<table>
<thead>
<tr>
<th>Event</th>
<th>Date</th>
</tr>
</thead>
<tbody>
<tr>
<td>Workshop/Special session proposal</td>
<td>February 14, 2021</td>
</tr>
<tr>
<td>Workshop/Special session acceptance</td>
<td>February 28, 2021</td>
</tr>
<tr>
<td>notification</td>
<td></td>
</tr>
<tr>
<td>Full/Poster Paper submission</td>
<td>April 4, 2021</td>
</tr>
<tr>
<td>Acceptance notification</td>
<td>April 18, 2021</td>
</tr>
<tr>
<td>Registration &amp; camera-ready papers</td>
<td>May 1, 2021</td>
</tr>
<tr>
<td>Conference Dates</td>
<td>July 7-9, 2021</td>
</tr>
</tbody>
</table>
IEEE/ACIS SNPD 2021 Proceedings will be published by IEEE Conference Publishing Services and will be submitted to be indexed by EI, INSPEC, and DBLP

Conference officers will select outstanding papers for publication in the following journals (www.acisinternational.org):

- International Journal of Networked and Distributed Computing (IJNDC), Paris, France
- International Journal of Software Innovation (IJSI), IGI Globe, U.S.A.
- Studies in Computational Intelligence (SCI), Springer, Germany

Conference officers are arranging two special issues of SCI-Indexed Journals to publish outstanding papers.

- Special Issue: Intelligent Data Analysis and Management Journal of Database Management (JDM)
- Special Issue: Knowledge-Based Intelligent Systems for Smart Computing International Journal of Computational Intelligence Systems (IJCIS)

Best Paper Award and Best Student Paper Awards will be conferred at the conference (in order to qualify for the award, the paper must be presented at the conference.)

Organizing Committee

General Chair:
Wen-Yuan Chen, National Chin-Yi University of Technology, Taiwan

Conference Chair:
Ing.habil.Roland Stenzel, University of Applied Sciences Dresden, Germany
Her-Terng Yau, National Chin-Yi University of Technology, Taiwan

Program Chair:
Mei-Ling Shyu, University of Miami, USA
Hsiung-Cheng Lin, National Chin-Yi University of Technology, Taiwan

Registration Co-Chair:
Ruey-Maw Chen, National Chin-Yi University of Technology, Taiwan

Local Arrangements Chair:
Yun-Long Lay, National Chin-Yi University of Technology, Taiwan

Publicity Co-Chairs:
Narayan Debnath, Eastern International University, Vietnam

Finance Chair:
Hsin-Chiang You, National Chin-Yi University of Technology, Taiwan

Publication Chair:
Shu-Ching Chen, Florida International University, USA
Trung Pham, University of Talca, Talca, Chile
Hao Ying, Wayne State University, USA
Ling-Ling Li, Hebei University of Technology, China
Jun-Juh Yan, National Chin-Yi University of Technology, Taiwan
Vincent CS Lee, Monash University, Australia
Worajit Setthapun (Sai), Chiang Mai Rajabhat University, Thailand